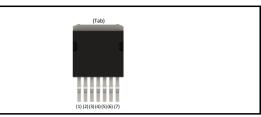


SCT4026DWAHR

Automotive Grade N-channel SiC power MOSFET

V _{DSS}	750V
R _{DS(on)} (Typ.)	26mΩ
I_{D}^{*1}	51A
P _D	150W

•Outline TO-263-7LA



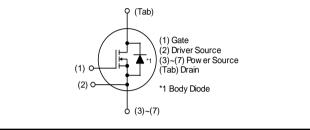
Features

- 1) Qualified to AEC-Q101
- 2) Low on-resistance
- 3) Fast switching speed
- 4) Fast reverse recovery
- 5) Easy to parallel
- 6) Simple to drive
- 7) Pb-free lead plating ; RoHS compliant
- 8) Wide creepage distance = min.4.7 mm

Application

- Automobile
- Switch mode power supplies

Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Packaging specifications

	Packing	Embossed tape
	Reel size (mm)	330
Tuno	Tape width (mm)	24
Туре	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT4026DWA

•Absolute maximum ratings (T_{vj} = 25°C unless otherwise specified.)

	=,				
Parameter		Symbol	Value	Unit	
Drain - source voltage		V _{DSS}	750	V	
Continuous drain		$T_c = 25^{\circ}C$	ı ı *1	51	Α
and source current	$V_{GS} = V_{GS_{on}}$	$T_c = 100^{\circ}C$	Ι _D , Ι _S ^{*1}	36	Α
Pulsed drain current	$V_{GS} = V_{GS_{on}}$	$T_c = 25^{\circ}C$	I _{D,pulse} *2	91	А
Body diode pulsed forwa	ard current	$T_c = 25^{\circ}C$	^{*1,*3} S,pulse	51	А
Body diode surge forward current		$V_{GS} = 0 V$	1,*4 ^{*1,*4}	91	Α
Gate - source voltage (DC)		V _{GSS_DC}	-4 to +21	V	
Gate - source surge voltage (t _{surge} < 300ns)		V_{GSS_surge} *5	-4 to +23	V	
Recommended turn-on gate - source drive voltage		V _{GS_on} *6	+15 to +18	V	
Recommended turn-off gate - source drive voltage		V _{GS_off}	0	V	
Virtual junction temperature		Τ _{vj}	175	°C	
Range of storage temperature		T _{stg}	-40 to +175	°C	

•Electrical characteristics ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

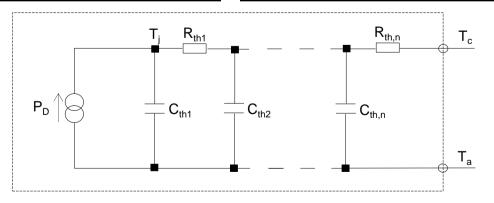
Parameter	Symbol	Conditions		Values			
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	\ /	$V_{GS} = 0 V, I_D = 9.2mA$ $T_{vi} = 25^{\circ}C$	750			V	
		,	750	-	-		
Zero Gate voltage		$V_{GS} = 0 V, V_{DS} = 750V$					
Drain current	I _{DSS}	T _{vj} = 25°C	-	1	80	μA	
		T _{vj} = 150°C	-	10	-		
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +21V$, $V_{DS} = 0V$	-	-	100	nA	
Gate - Source leakage current		$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA	
Gate threshold voltage	$V_{GS(th)} {}^{*7}$	$V_{DS} = 10V, I_{D} = 15.4mA$	2.8	-	4.8	V	
		$V_{GS} = 18V, I_D = 29A$					
Static Drain - Source on - state resistance	${\sf R}_{\sf DS(on)}$ *8	T _{vj} = 25°C	-	26	34	mΩ	
		T _{vj} = 150°C	-	44	-		
Gate input resistance	R _G	f = 1MHz, open drain	-	1	-	Ω	

Thermal resistance

Parameter	Symbol	Values			Unit
	Symbol	Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	${\sf R}_{\sf thJC}$ *9	-	0.79	1.0	K/W

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	5.1 ×10 ⁻²		C _{th1}	8.8 ×10 ⁻⁴	
R _{th2}	3.6 ×10 ⁻¹	K/W	C _{th2}	4.5 ×10 ⁻³	Ws/K
R _{th3}	3.8 ×10 ⁻¹		C _{th3}	1.3 ×10 ⁻¹	



•Electrical characteristics ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

Doromotor	Symbol Conditions		Values			L locit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	g _{fs} *8	$V_{DS} = 10V, I_{D} = 29A$	-	16	-	S
Input capacitance	C_{iss}	$V_{GS} = 0V$	-	2320	-	
Output capacitance	C_{oss}	V _{DS} = 500V	-	111	-	pF
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	9	-	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V$ to 500V	-	143	-	pF
Total Gate charge	Q_g^{*8}	V _{DS} = 500V I _D = 29A	-	94	-	
Gate - Source charge	Q _{gs} *8	$V_{GS} = 18V$	-	20	-	nC
Gate - Drain charge	Q _{gd} *8	See Fig. 1-1, 1-2.	-	23	-	
Turn - on delay time	t _{d(on)} *8	$V_{DS} = 500V$ $I_{D} = 29A$	-	9.5	-	
Rise time	t _r *8	V _{GS} = +18V / 0V	-	22	-	ns
Turn - off delay time	t _{d(off)} *8	$R_G = 6.8\Omega$, L = 250µH E _{on} includes diode	-	45	-	115
Fall time	t _f *8	reverse recovery $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF	-	13	-	
Turn - on switching loss	E _{on} *8	See Fig. 2-1, 2-2, 2-3.	-	213	-	
Turn - off switching loss	E _{off} *8		-	73	-	μJ

•Body diode electrical characteristics (Source-Drain) ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Forward voltage	V_{SD} *8	$V_{GS} = 0V, I_S = 29A$	-	3.3	-	V
Reverse recovery time	t _{rr} *8	$I_F = 29A$ $V_R = 500V$	-	12	-	ns
Reverse recovery charge	Q _{rr} *8	di/dt = 2700A/µs	-	141	-	nC
Peak reverse recovery current	I _{rrm} *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	24	-	А

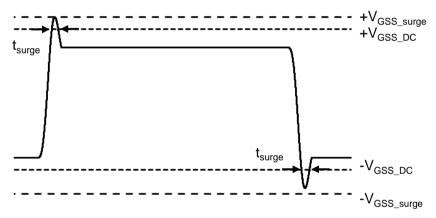
*1 Limited by maximum T_{vi} and for Max. R_{thJC} .

*2 Pulse width and duty cycle are limited by $T_{\nu j,\text{max}}$

*3 Only for body-diode, Repititive pulse, PW \leq 1.5µs, Duty cycle \leq 5%

*4 When used as a protective function, PW \leq 10µs

*5 Example of acceptable V_{GS} waveform



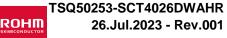
- *6 Please be advised not to use SiC-MOSFETs with V_{GS} below 10V as doing so may cause thermal runaway.
- *7 Tested after applying V_{GS} = 21V for 100ms.

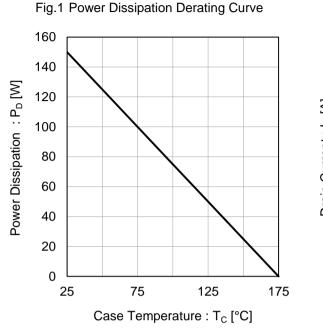
*8 Pulsed

*9 Measured conformable to JESD51-14.

See the application note "rthjc_measurement_and_usage_an-e.pdf". Link

 ${\tt URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc_measurement_and_usage_an-e.pdf}$





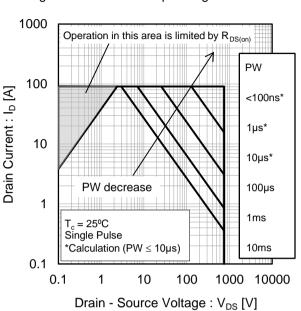


Fig.2 Maximum Safe Operating Area

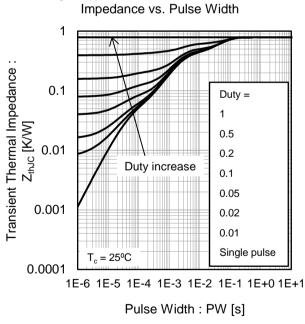


Fig.3 Typical Transient Thermal

0.0001 1E-6 1E-5 1E-4 1E-3 1E-2 1E Pulse Width : PW



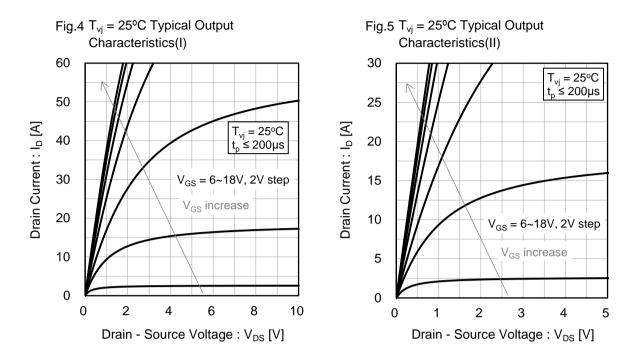
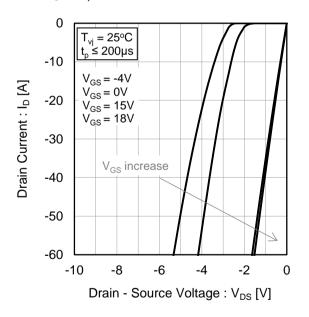
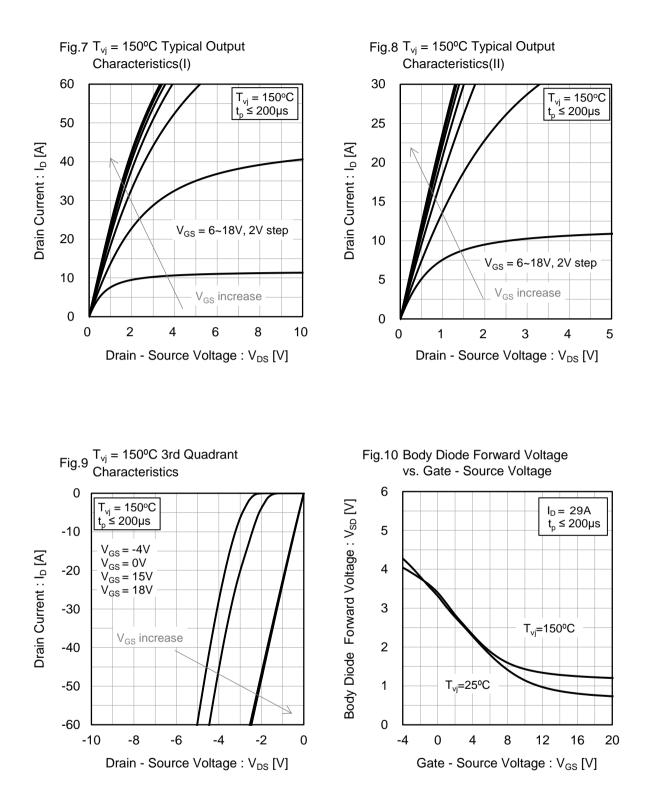


Fig.6 T_{vj} = 25°C 3rd Quadrant Characteristics





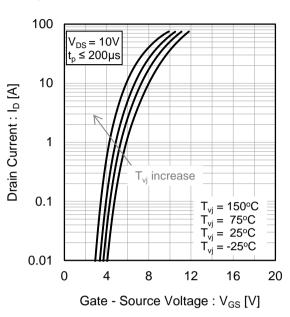
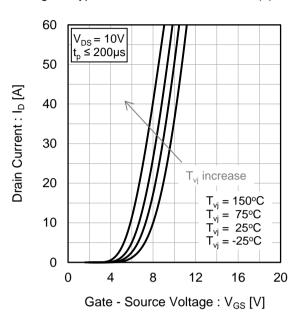


Fig.11 Typical Transfer Characteristics (I)

Fig.12 Typical Transfer Characteristics (II)



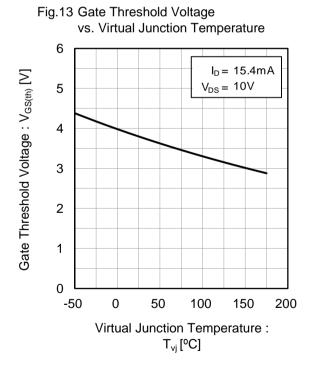
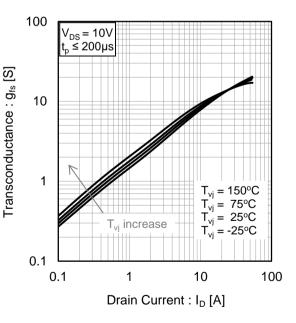
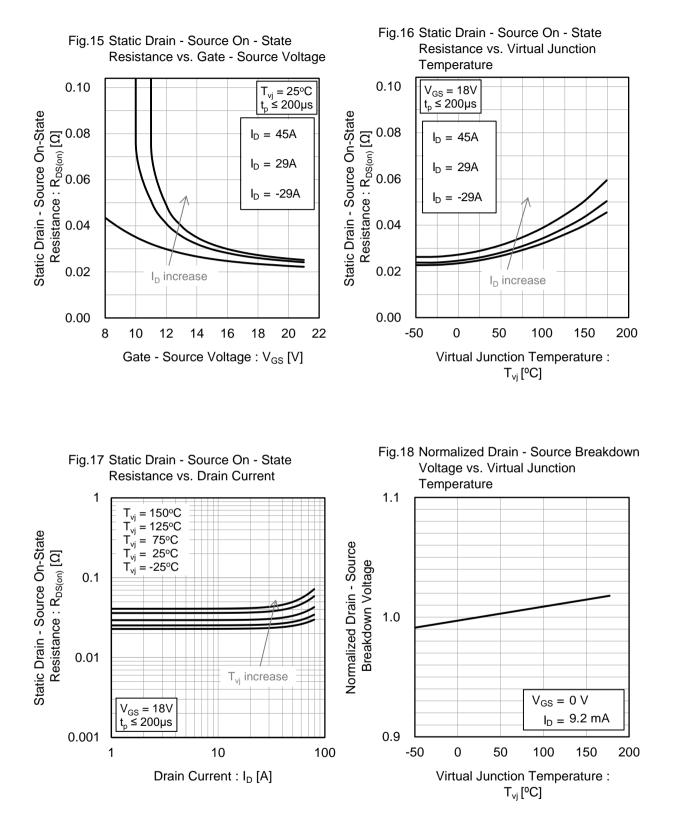


Fig.14 Transconductance vs. Drain Current





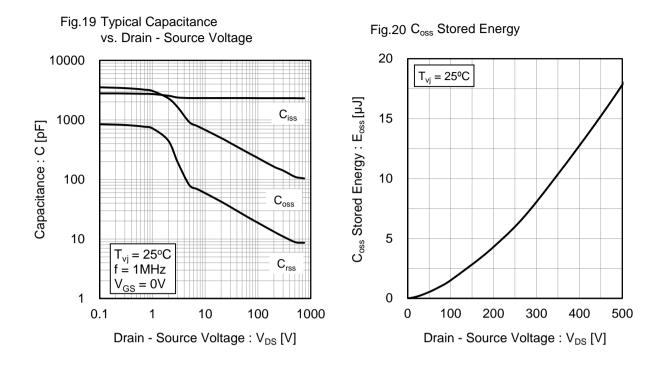
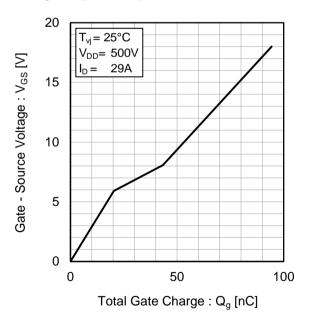
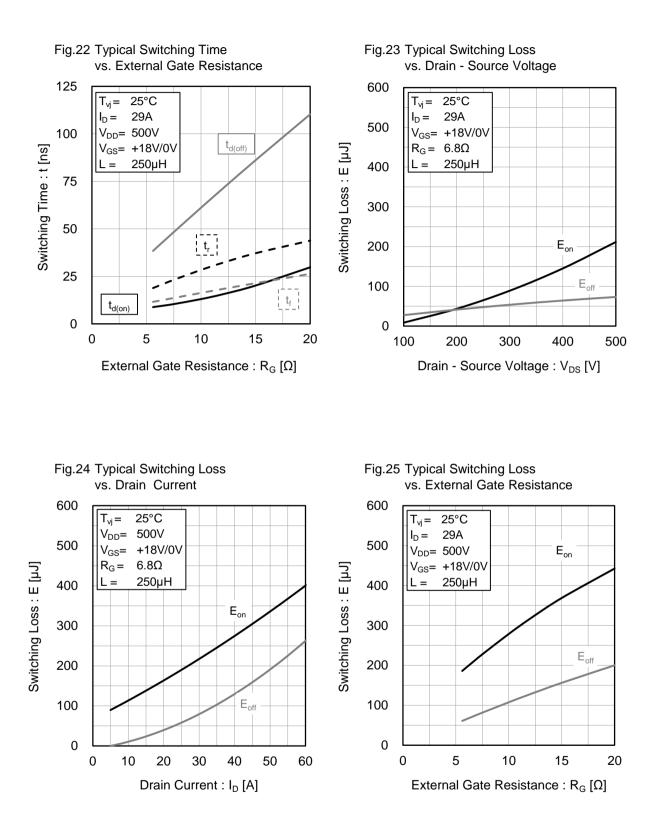
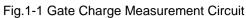


Fig.21 Dynamic Input Characteristics





Measurement circuits and waveforms



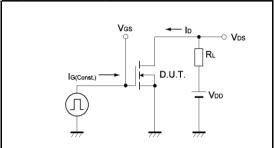


Fig.2-1 Switching Characteristics Measurement Circuit

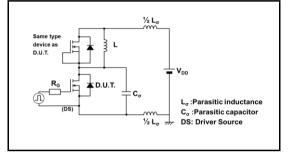


Fig.2-3 Waveforms for Switching Energy Loss

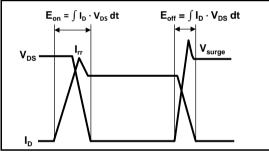


Fig.3-1 Reverse Recovery Time Measurement Circuit

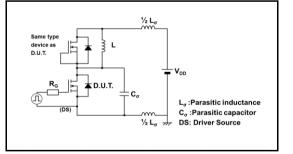


Fig.1-2 Gate Charge Waveform

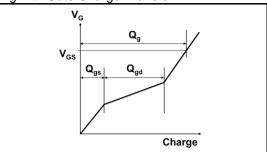


Fig.2-2 Waveforms for Switching Time

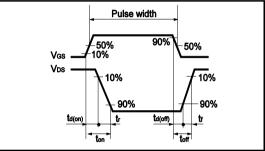
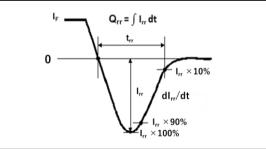
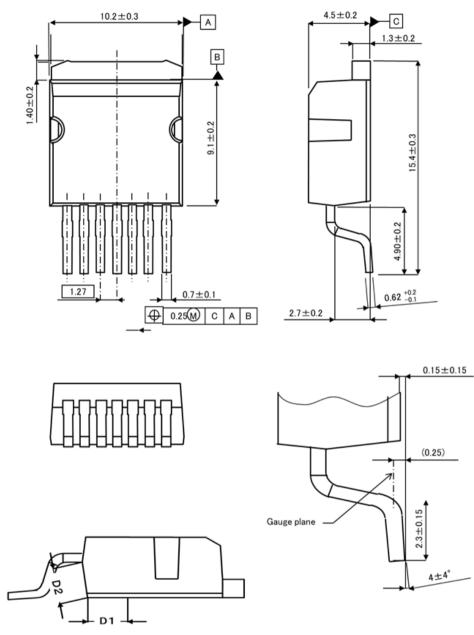


Fig.3-2 Reverse Recovery Waveform

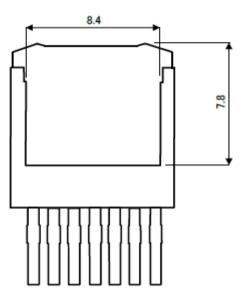


Package Dimensions

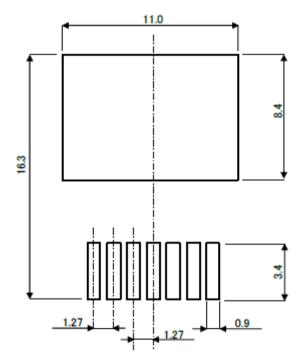


Minimum Creepage Distance = 4.7mm (D1+D2)

Unit: mm

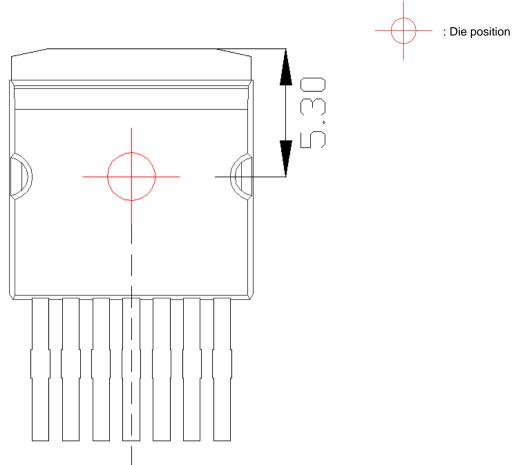


RECOMMENDED FOOTPRINT DIMENSIONS



Unit: mm

Die Bonding Layout

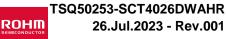


•Front view of the packaging.

•Dimensions are design values.

·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm



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